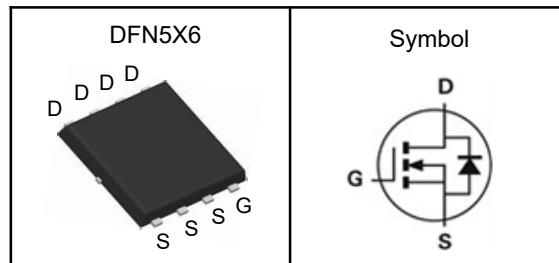


N-Channel Enhancement Mode MOSFET

Features

- Low $R_{DS(on)}$ for low conduction loss
- Reliable and Rugged
- ROHS Compliant & Halogen-Free

Pin Description



Applications

- Power Management in Desktop Computer
- DC/DC Converters

V_{DSS}	80	V
$R_{DS(ON)-Typ}$	10	$\mu\Omega$
I_D	60	A

Absolute Maximum Ratings ($T_J=25^\circ C$, Unless Otherwise Noted)

Symbol	Parameter	Rating	Unit
V_{DSS}	Drain-Source Voltage	80	V
V_{GSS}	Gate-Source Voltage	± 20	V
T_J	Maximum Junction Temperature	-55 to 150	$^\circ C$
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ C$
E_{AS}	Single Pulse Avalanche Energy ^③	180	mJ
$I_{DM}^{①}$	Pulse Drain Current Tested	204	A
I_D	Continuous Drain Current	$T_c=25^\circ C$	A
P_D	Maximum Power Dissipation	$T_c=25^\circ C$	W

Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{\theta JA}$	Thermal Resistance-Junction to Ambient	62	$^\circ C/W$
$R_{\theta JC}$	Thermal Resistance Junction-Case ^④	2.1	$^\circ C/W$

Note ① : Max. current is limited by bonding wire.

Note ② : UIS tested and pulse width are limited by maximum junction temperature $150^\circ C$.

Note ③ : Surface Mounted on 1in² FR-4 board with 1oz.

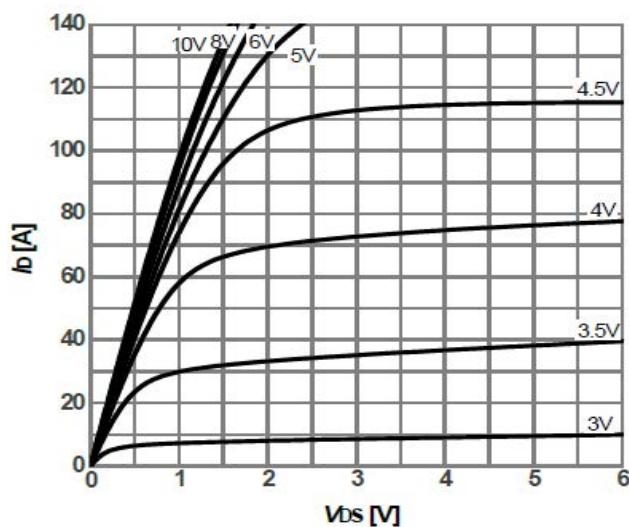
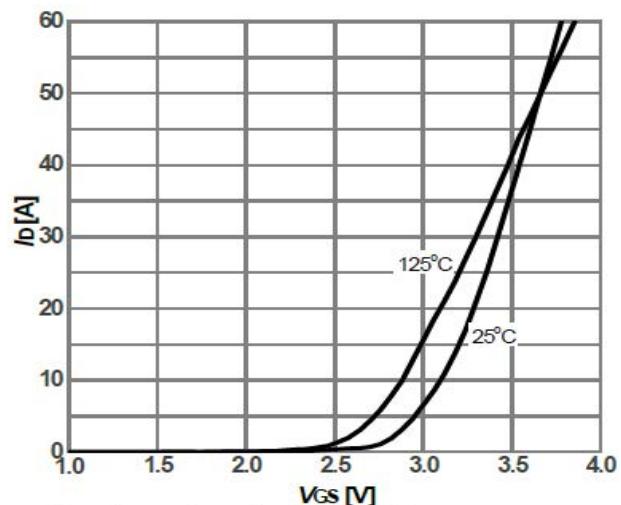
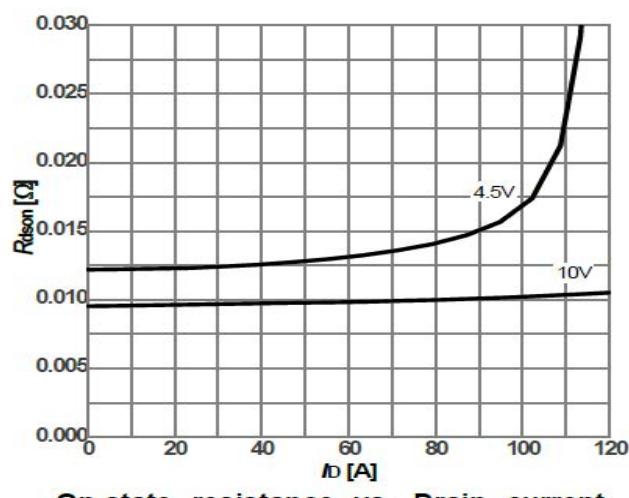
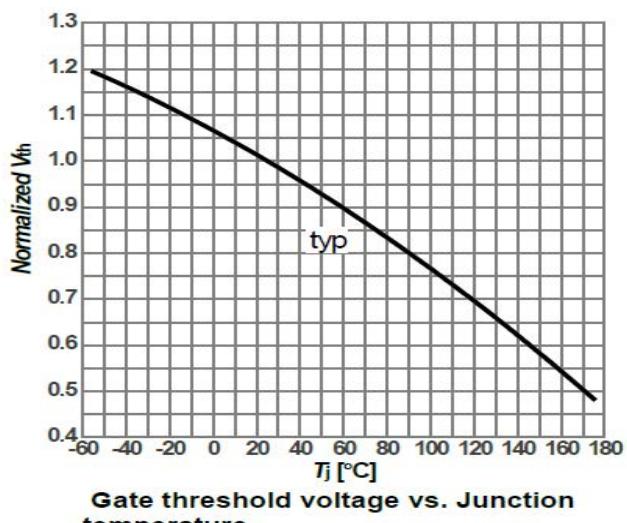
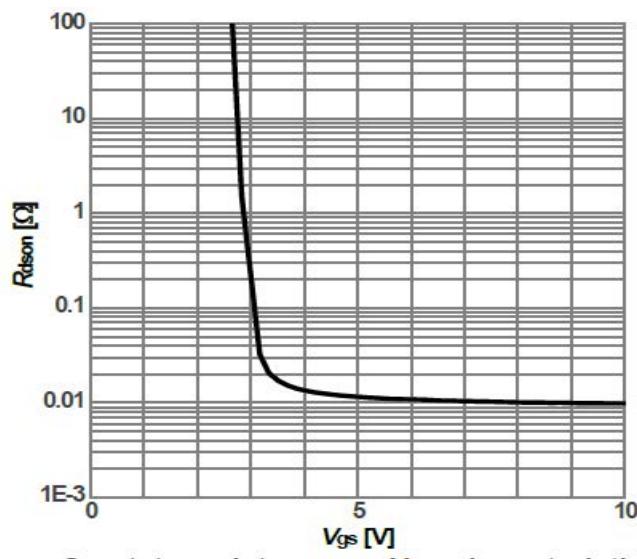
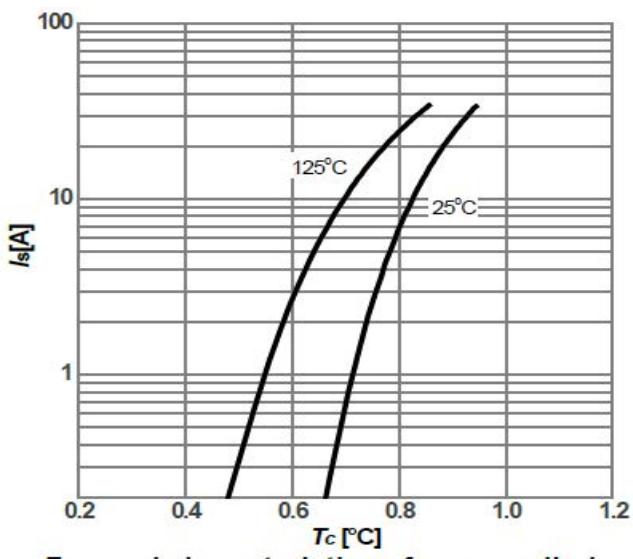
N-Channel Enhancement Mode MOSFET

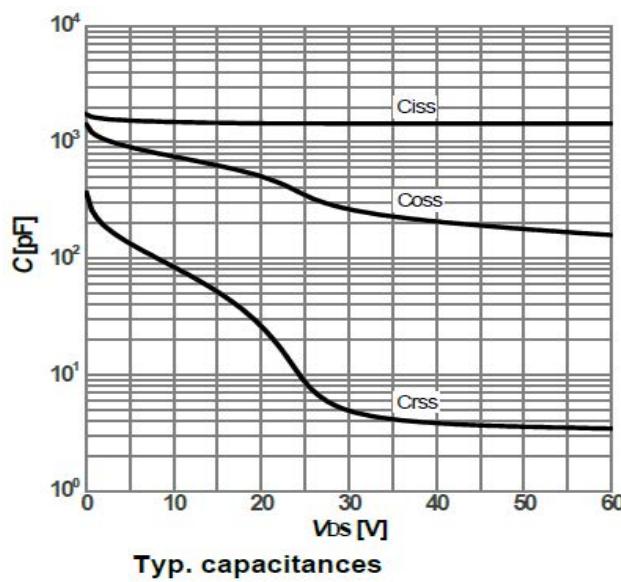
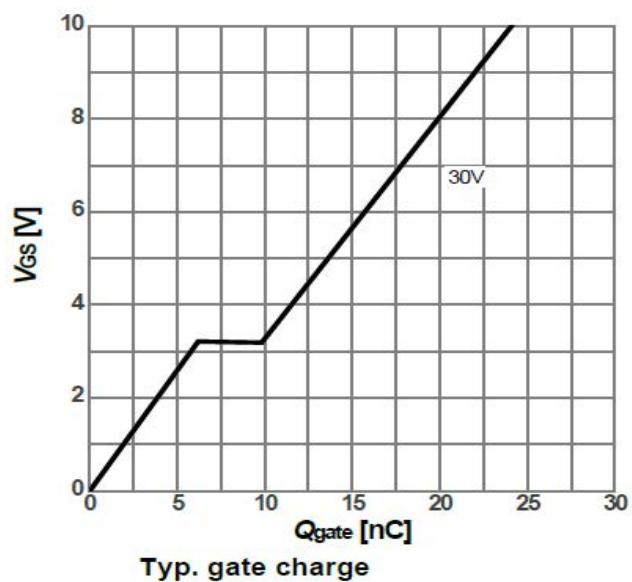
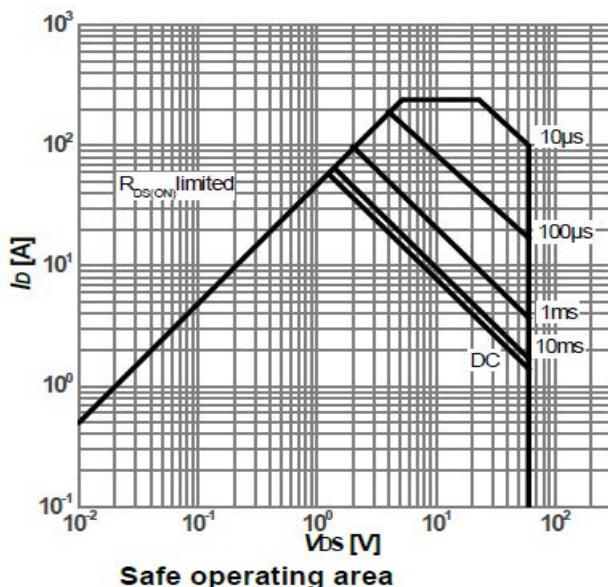
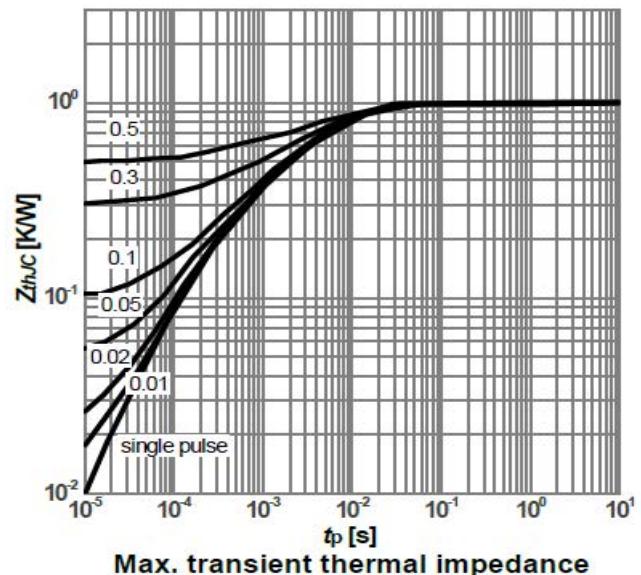
Electrical Characteristics ($T_J=25^\circ\text{C}$, Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
Static Electrical Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_{\text{D}}=250\mu\text{A}$	80	---	---	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=80\text{V}$, $V_{\text{GS}}=0\text{V}$	---	---	1	μA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_{\text{D}}=250\mu\text{A}$	1.0	---	2.5	V
I_{GSS}	Gate Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$	---	---	± 100	nA
$R_{\text{DS(ON)}}$	Drain-Source On-state Resistance	$V_{\text{GS}}=10\text{V}$, $I_{\text{D}}=15\text{A}$	---	10	15	$\text{m}\Omega$
Dynamic Characteristics^⑤						
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=40\text{V}$, Freq.=1MHz	---	1400	---	pF
C_{oss}	Output Capacitance		---	190	---	
C_{rss}	Reverse Transfer Capacitance		---	4	---	
$T_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{DD}}=40\text{V}$, $V_{\text{GS}}=10\text{V}$, $R_{\text{G}}=3\Omega$, $I_{\text{D}}=14.5\text{A}$	---	19	---	nS
T_{r}	Turn-on Rise Time		---	10	---	
$T_{\text{d(off)}}$	Turn-off Delay Time		---	24	---	
T_{f}	Turn-off Fall Time		---	5	---	
Q_{g}	Total Gate Charge	$V_{\text{DS}}=40\text{V}$, $V_{\text{GS}}=10\text{V}$, $I_{\text{D}}=14.5\text{A}$	---	23	---	nC
Q_{gs}	Gate-Source Charge		---	6.2	---	
Q_{gd}	Gate-Drain Charge		---	3.3	---	
Source-Drain Characteristics ($T_J=25^\circ\text{C}$)						
$V_{\text{SD}}^{④}$	Diode Forward Voltage	$I_{\text{S}}=1\text{A}$, $V_{\text{GS}}=0\text{V}$	---	0.7	1.2	V
t_{rr}	Reverse Recovery Time	$I_{\text{F}}=10\text{A}$, $V_{\text{R}}=30\text{V}$ $dI/dt=100\text{A}/\mu\text{s}$, $T_J=25^\circ\text{C}$	---	19	---	nS
Q_{rr}	Reverse Recovery Charge		---	61	---	nC

Note ④ : Pulse test (pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$).

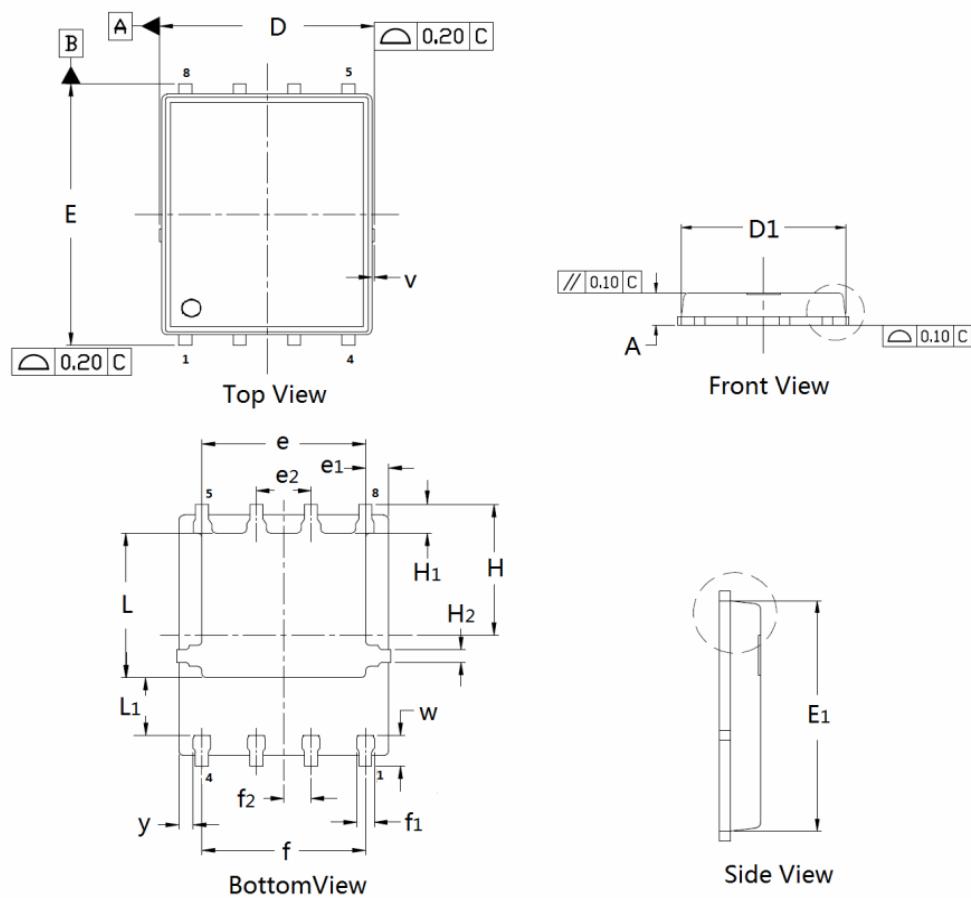
Note ⑤ : Guaranteed by design, not subject to production testing.

N-Channel Enhancement Mode MOSFET
Typical Characteristics

Typ. output characteristics

Typ. transfer characteristics

On-state resistance vs. Drain current

Gate threshold voltage vs. Junction temperature

On-state resistance vs. Vgs characteristics

Forward characteristics of reverse diode

N-Channel Enhancement Mode MOSFET

Typ. capacitances

Typ. gate charge

Safe operating area

Max. transient thermal impedance

N-Channel Enhancement Mode MOSFET

DFN5×6 Package Outline Data



DIMENSIONS (unit : mm)

Symbol		Typ	Max	Symbol	Min	Typ	Max
A	0.90	1.02	1.10	D	4.90	4.98	5.10
D₁	4.80	4.89	5.10	E	5.90	6.11	6.25
E₁	5.65	5.74	5.95	e	3.72	3.80	3.92
e₁	--	0.5	--	e₂	--	1.	--
f	--	3.8	--	f₁	0.31	0.37	0.51
f₂	--	0.6	--	H	--	3.	--
H₁	0.59	0.63	0.79	H₂	0.26	0.28	0.32
L	3.35	3.45	3.65	L₁	--	1.	--
V	--	0.1	--	w	0.64	0.68	0.84
y	--	0.3	--		--		--